



17438

Docket No.: TOMC 8188

Date: January 30, 2003

In re application of: Mary R. Reidmeier, et al.	
Serial No.: 10/044,704	Group No.: 1743
Filed: November 9, 2001	Examiner: Ta Hsung Tung
For: CHEMICAL PLATING METHOD, ELECTROLYTIC CELL AND AUTOMOTIVE OXYGEN SENSOR USING IT	

Box FEE AMENDMENT
Commissioner for Patents
Washington, D.C. 20231

Sir:

Transmitted herewith is an amendment in the above-identified application in response to the Office Action dated July 30, 2002, including translation of Japanese patent and dictionary entry.

Please regard this as a Request For Extension of Time for 3 months.

Small Entity Status claimed.

The fee has been calculated as shown:

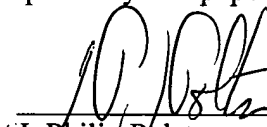
CLAIMS AS AMENDED

	Claims Remaining After Amendment	Highest No. Previously Paid For	Present Extra	Rate - Other Than A Small Entity	Rate - Small Entity	Additional Fee
Total Claims	11 -	20 =	0	\$18.00	\$9.00	0.00
Indep. Claims	1 -	3 =	0	\$84.00	\$42.00	0.00

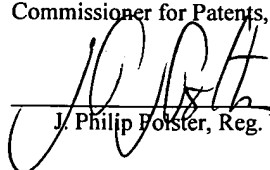
Total Additional Fee:

\$0.00

☒ A check in the amount of \$465.00 is enclosed to cover the fee for 3 months extension of time. The Commissioner is hereby authorized to charge any additional fees or credit overpayment under 37 CFR 1.16 and 1.1, which may be required by this paper to Deposit Account 162201.
Duplicate copies of this sheet are enclosed.


J. Philip Polster
Registration No: 24,739

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on January 30, 2003.


J. Philip Polster, Reg. No. 24,739

1/30/03
Date of Signature



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Mary R. Reidmeier, et al.

ART UNIT: 1743

SERIAL NO.: 10/044,704

EXAMINER: TA HSUNG TUNG

FILED: NOVEMBER 9, 2001

DOCKET NO.: TOMC 8188US

FOR: CHEMICAL PLATING METHOD, ELECTROLYTIC CELL
AND AUTOMOTIVE OXYGEN SENSOR USING IT

4/A
W.M.
2/12/03

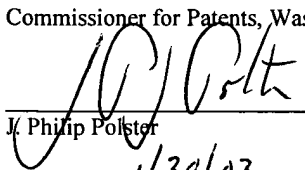
St. Louis, Missouri
January 30, 2003

Assistant Commissioner for Patents
Washington, D.C. 20231

AMENDMENT A

The official letter dated July 30, 2002, has been received, and in response thereto
the above-identified application is amended as follows.

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Commissioner for Patents, Washington, D.C. 20231 on January 30, 2003


J. Philip Polster

Date

1/30/03

02/05/2003 DEMMANU1 00000053 10044704

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